**PATENT ASSIGNMENT COVER SHEET**

**SUBMISSION TYPE:** NEW ASSIGNMENT

**NATURE OF CONVEYANCE:** ASSIGNMENT

### CONVEYING PARTY DATA

<table>
<thead>
<tr>
<th>Name</th>
<th>Execution Date</th>
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<tbody>
<tr>
<td>TIM CHUNG-TING WU</td>
<td>12/27/2013</td>
</tr>
<tr>
<td>CHENG-CHIEH CHUANG</td>
<td>03/18/2014</td>
</tr>
<tr>
<td>CHI-JEN LU</td>
<td>12/30/2013</td>
</tr>
<tr>
<td>CHUN-LUNG CHU</td>
<td>03/18/2014</td>
</tr>
<tr>
<td>CHIEN-HUNG LIN</td>
<td>03/18/2014</td>
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### RECEIVING PARTY DATA

<table>
<thead>
<tr>
<th>Name:</th>
<th>HTC CORPORATION</th>
</tr>
</thead>
<tbody>
<tr>
<td>Street Address:</td>
<td>NO.23, XINGHUA RD., TAOYUAN CITY,</td>
</tr>
<tr>
<td>City:</td>
<td>TAOYUAN COUNTY</td>
</tr>
<tr>
<td>State/Country:</td>
<td>TAIWAN</td>
</tr>
<tr>
<td>Postal Code:</td>
<td>330</td>
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**PROPERTY NUMBERS Total: 1**

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<tr>
<th>Property Type</th>
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<tr>
<td>Application Number</td>
<td>14183534</td>
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**CORRESPONDENCE DATA**

Fax Number: (510)580-7280

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.*

Email: USA@JCIPGroup.com.tw

Correspondent Name: JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE

Address Line 1: 7F.-1, NO. 100, ROOSEVELT RD., SEC. 2,

Address Line 4: TAIPEI, TAIWAN 100

**ATTORNEY DOCKET NUMBER:** 46648-US-PA

**NAME OF SUBMITTER:** BELINDA LEE

**SIGNATURE:** /Belinda Lee/

**DATE SIGNED:** 04/21/2014

Total Attachments: 4

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ASSIGNMENT

WHEREAS,

1. Tim Chung-Ting Wu
2. Cheng-Chieh Chuang
3. Chi-Jen Lu
4. Chun-Lung Chu
5. Chien-Hung Lin

hereinafter referred to as ASSIGNOW, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: Casing Of Electronic Device And Method Of Manufacturing The Same

Filed: February 19, 2014 Serial No. 14/183,534

[ ] Executed concurrently with the execution of this instrument

WHEREAS, HTC Corporation

of No.23, Xinghua Rd., Taoyuan City, Taoyuan County 330, Taiwan (R.O.C.)

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and Instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.
ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: [Signature] Date: 12/7/13
Sole or First Joint Inventor: Tim Chung-Ting Wu

Signature: [Signature] Date: 
Second Joint Inventor (if any): Cheng-Chieh Chuang

Signature: [Signature] Date: 
Third Joint Inventor (if any): Chi-Jen Lu

Signature: [Signature] Date: 
Fourth Joint Inventor (if any): Chun-Lung Chu

Signature: [Signature] Date: 
Fifth Joint Inventor (if any): Chien-Hung Lin
ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: ___________________________ Date: ___________________________
Sole or First Joint Inventor: Tim Chung-Ting Wu

Signature: Cheng-Chieh Chuang
Date: 2014/3/18
Second Joint Inventor (if any): Cheng-Chieh Chuang

Signature: ___________________________ Date: ___________________________
Third Joint Inventor (if any): Chi-Jen Lu

Signature: Chun-Lung Chu
Date: 2014/2/18
Fourth Joint Inventor (if any): Chun-Lung Chu

Signature: Chien-Hung Lin
Date: 2014/2/18
Fifth Joint Inventor (if any): Chien-Hung Lin
ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: ____________________________ Date: ____________________________
Sole or First Joint Inventor: Tim Chung-Ting Wu

Signature: ____________________________ Date: ____________________________
Second Joint Inventor (if any): Cheng-Chieh Chuang

Signature: ____________________________ Date: 2013/11/20
Third Joint Inventor (if any): Chi-Jen Lu

Signature: ____________________________ Date: ____________________________
Fourth Joint Inventor (if any): Chun-Lung Chu

Signature: ____________________________ Date: ____________________________
Fifth Joint Inventor (if any): Chien-Hung Lin